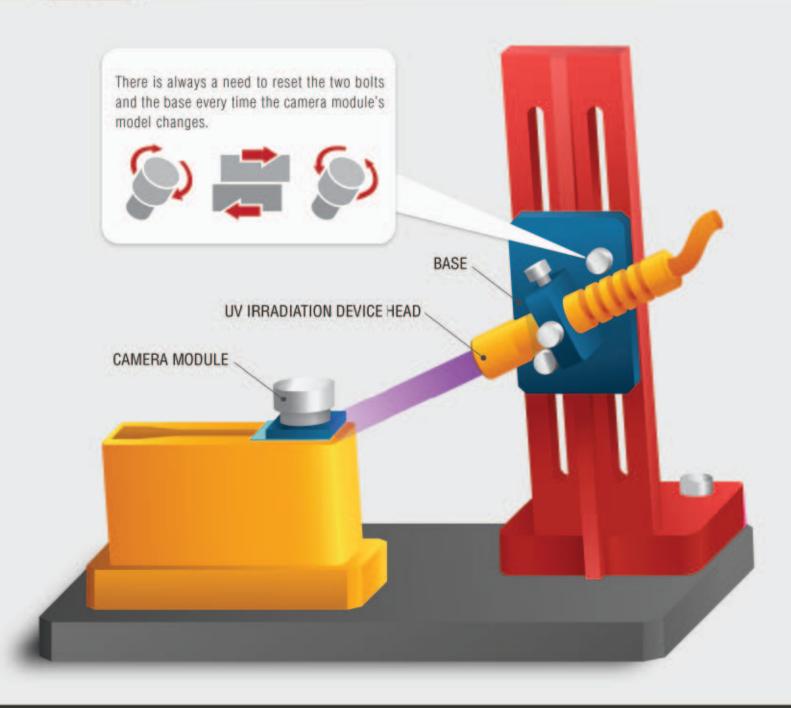








SETTING THE HEIGHT OF THE UV BONDER'S HEAD IS INEFFICIENT.





The camera module's housing and circuit board are to be UV-bonded. Every time the model of the camera module to be manufactured changes, the height and position of the UV bonder have to be adjusted in accordance. In addition, UV bonding of the housing and circuit board has to be conducted in four directions, so four head settings are also necessary – leading to more resetting of the bonder (Note: The above diagram only shows one setting.).



WITH THE USE OF THE Z-AXIS STAGE, SETTING THE HEIGHT OF THE UV BONDER IS NOW SPEEDY, STABLE AND EASY.

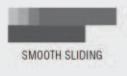




Dealing with loosening and retightening of bolts, etc. are not necessary with the use of the Z-Axis Stage. Moreover, the height can be maintained firmly without shifting by tightening the stopper.

Even small adjustments can be easily done because of the smooth handle operation, improving speed and accuracy.

Z-AXIS STAGE (ZTSC-120)









STAGE SURFACE: 25MM X 40MM





WEIGHT: 0.2 KG





SATIN BLACK ANODIZED ALUMINUM



USING THE Z-AXIS STAGE TOGETHER WITH THE XY-AXIS STAGE OR THE ROTARY STAGE ALLOWS FOR MORE EFFICIENCY.

n the above case, for example, setting up the bonder's head with the XY Stage, and using the Rotary Stage for the head's tilt, can lead to improved workability with the workpiece.

Combining the use of various stages, depending on the operation, allows for more efficiency in the work environment.

